

SL-SMT 3.50/03/135F 3.2SN BK BX**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com**Product image**

High-temperature-resistant male header, 3.50 mm pitch.

- **Plugging direction parallel (90°), straight 180° or angled (135°) to PCB**
- **Housing variants: closed side (G), screw flange (F), solder flange (LF) or snap-on solder flange (RF)**
- **Optimised for the SMT process**
- **Pin length 3.2 mm universal for all soldering methods**
- **Pin length 1.5 mm optimised for reflow soldering methods**
- **Packed either in a box (BX) or tape-on-reel (RL)**
- **Male header can be coded**

General ordering data

Version	PCB plug-in connector, male header, Flange, THT/THR solder connection, 3.50 mm, Number of poles: 3, 135°, Solder pin length (l): 3.2 mm, tinned, black, Box
Order No.	1003520000
Type	SL-SMT 3.50/03/135F 3.2SN BK BX
GTIN (EAN)	4032248700158
Qty.	102 pc(s).
Product data	IEC: 320 V / 15 A UL: 300 V / 10 A
Packaging	Box

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Technical data

Dimensions and weights

Depth	13.2 mm	Depth (inches)	0.52 inch
Height	16.2 mm	Height (inches)	0.638 inch
Height of lowest version	13 mm	Width	17.5 mm
Width (inches)	0.689 inch	Net weight	1.827 g

System specifications

Product family	OMNIMATE Signal - series BL/SL 3.50		
Type of connection	Board connection		
Mounting onto the PCB	THT/THR solder connection		
Pitch in mm (P)	3.5 mm		
Pitch in inches (P)	0.138 "		
Outgoing elbow	135°		
Number of poles	3		
Number of solder pins per pole	1		
Solder pin length (l)	3.2 mm		
Solder pin dimensions	d = 1.2 mm, Octagonal		
Solder eyelet hole diameter (D)	1.3 mm		
Solder eyelet hole diameter tolerance (D)+	0,1 mm		
Outside diameter of solder pad	2.3 mm		
Template aperture diameter	2.1 mm		
L1 in mm	7 mm		
L1 in inches	0.276 "		
Number of rows	1		
Pin series quantity	1		
Touch-safe protection acc. to DIN VDE 57 106	finger-safe plugged/ back-of-hand-safe unplugged		
Touch-safe protection acc. to DIN VDE 0470	IP20 plugged/ IP10 unplugged		
Protection degree	IP10		
Volume resistance	≤5 mΩ		
Plugging cycles	25		
Plugging force/pole, max.	10 N		
Pulling force/pole, max.	8 N		
Tightening torque	Torque type	Mounting screw, PCB	
	Usage information	Tightening torque	min. 0.1 Nm max. 0.15 Nm
		Recommended screw	Part number PTSC KA 2.2X4.5 WN1412

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Cu-alloy
Contact surface	tinned	Layer structure of solder connection	2...4 µm Ni / 5...8 µm Sn glossy
Layer structure of plug contact	2...4 µm Ni / 5...8 µm Sn glossy	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	100 °C		

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Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	15 A
Rated current, max. number of poles (Tu=20°C)	12 A	Rated current, min. number of poles (Tu=40°C)	13 A
Rated current, max. number of poles (Tu=40°C)	10 A	Rated voltage for surge voltage class / pollution degree II/2	320 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	160 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	2.5 kV		

Rated data acc. to CSA

Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	10 A	Rated current (Use group D / CSA)	10 A

Rated data acc. to UL 1059

Institute (UR)		Certificate No. (UR)	E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group B / UL 1059)	10 A	Rated current (Use group D / UL 1059)	10 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Packing

Packaging	Box	VPE length	350 mm
VPE width	135 mm	VPE height	25 mm

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ETIM 9.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01
ECLASS 12.0	27-46-02-01	ECLASS 13.0	27-46-02-01

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Technical data**Important note**

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	<ul style="list-style-type: none"> • Gold-plated contact surfaces on request • Rated current related to rated cross-section & min. No. of poles. • Diameter of solder eyelet D = 1.4+0.1mm • Solder eyelet diameter D = 1.5 + 0.1 mm, from 9 poles • P on drawing = pitch • Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. • In accordance with IEC 61984, OMNIMATE-connectors are connectors without breaking capacity (COC). During designated use, connectors are not allowed to be engaged or disengaged when live or under load • Long term storage of the product with average temperature of 50 °C and maximum humidity 70%, 36 months

Approvals

Approvals



ROHS	Conform
UL File Number Search	UL Website
Certificate No. (UR)	E60693

Downloads

Approval/Certificate/Document of Conformity	Declaration of the Manufacturer
Engineering Data	CAD data – STEP
Catalogues	Catalogues in PDF-format
Brochures	FL DRIVES EN MB SMT EN FL DRIVES DE MB DEVICE MANUF. EN FL BUILDING SAFETY EN FL APPL LED LIGHTING EN FL INDUSTR.CONTROLS EN FL MACHINE SAFETY EN FL HEATING ELECTR EN FL APPL INVERTER EN FL BASE STATION EN FL ELEVATOR EN FL POWER SUPPLY EN FL 72H SAMPLE SER EN PO OMNIMATE EN PO OMNIMATE EN
White paper surface mount technology	Download Whitepaper

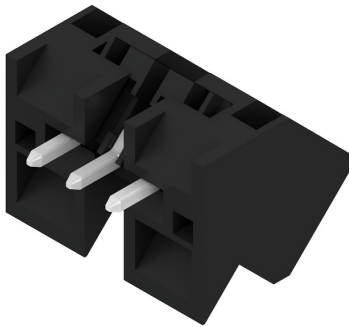
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Drawings

Product image



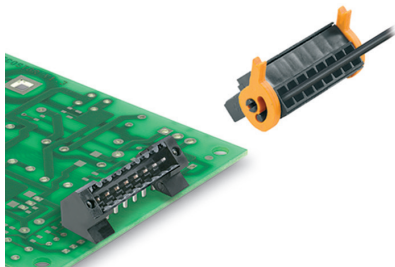
Dimensional drawing



LAYOUT FINISHED HOLES

Similar to illustration

Example of use



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Accessories

Coding elements

**Only connects what is supposed to be connected:
the right connection at the right place.**

Coding elements and locking devices clearly assign connecting elements during the manufacturing process and operation

The coding elements and locking devices are inserted prior to assembly or during the cable assembly phase. The Weidmüller alternative: configure online using the variant configurator to precode prior to delivery.

Incorrect assembly on the circuit board and incorrect plugging of connecting elements is no longer possible. The advantage: no troubleshooting during manufacture and no operational errors by the user.

General ordering data

Type	BL SL 3.5 KO OR	Version	Product data	Packaging
Order No.	1693430000	PCB plug-in connector, Accessories, Coding element, orange, Number		Box
GTIN (EAN)	4008190867447	of poles: 1		
Qty.	100 pc(s).			
Type	BL SL 3.5 KO SW	Version	Product data	Packaging
Order No.	1610100000	PCB plug-in connector, Accessories, Coding element, black, Number		Box
GTIN (EAN)	4008190187637	of poles: 1		
Qty.	100 pc(s).			

Rev.

Material data

Insulation material type	LCP
Insulation material colors	black
Insulation material flammability class	UL94
Insulation resistance	MOhm
Contact base material	CuSn
Contact plating (mating end)	see order sheet
Contact plating (solder end)	see order sheet

System characteristic values

together with counterpart

BL 3.5

Pitch P	mm/inch	3.5/0.138	
Number of rows		1	
Dielectric strength (r.m.s withstand voltage)	kV	>2.2	
Mechanical operating cycles	acc.to IEC512	25	
Plug in force (max.)	N/Pole	10	1)
Pull out force (max.)	N/Pole	10	1)
Through resistance (typical)	m Ohm	4.5	
Operating temperatur range	°C	-20..100	2)
Degree of protection acc. to VDE 0106 (plugged/unplugged)		finger safe/back of hands	
Degree of protection acc. to DIN EN 60529(plugged/unplugged)		IP20/IP10	
Solder pin length L	mm/inch	3.2/0.126	
PCB hole diameter D (wave soldering)	mm/inch	1.3+0.1/0.51+0.004	3)
PCB hole diameter D (reflow soldering)	mm/inch	n.a.	4)
Resistance to soldering heat acc. to DIN IEC 60512-6	°C/sec	-	5)
Resistance to soldering heat acc. to EN 61760-1	°C/sec	290/30	6)
Solderability classification acc. to EN 61760-1		class A	
Solder connection type		Reflow	
Solder pin diameter d (max.)	mm/inch	1.2/0.047	

Application notes

Coding possibility	yes/no	yes (accessory)
Joinable without loss of pitch	yes/no	no
Manual assembly of modules	yes/no	no
Max. number of poles	n	24

IEC 664-1 / VDE0110 (4.97) rated data

Rated cross section acc. to EN 60999	mm ²	n.a.	
Rated current @ 20°C ambient (together with)	A	16.8 (BL3.5)	7)
Rated current @ 40°C ambient (together with)	A	14.4 (BL3.5)	7)
Overvoltage category / Pollution degree		III/3 III/2 II/2	
Rated voltage	V	160 160 250	
Rated impulse voltage	kV	2.5 2.5 2.5	

UL 1059 rated data



Rated voltage	V	300	-	300
Rated current	A	10	-	10
AWG wire range (field wiring / factory wiring)		n.a.		

CSA C22.2 rated data



Rated voltage	300	-	300
Rated current	10	-	10
AWG wire range (field wiring / factory wiring)	n.a.		

Packaging

cardbox

Downloads

www.weidmueller.de..



LAYOUT FINISHED HOLES

24	80,50	3,169
23	77,00	3,031
22	73,50	2,894
21	70,00	2,756
20	66,50	2,618
19	63,00	2,480
18	59,50	2,343
17	56,00	2,205
16	52,50	2,067
15	49,00	1,929
14	45,50	1,791
13	42,00	1,654
12	38,50	1,516
11	35,00	1,378
10	31,50	1,240
9	28,00	1,102
8	24,50	0,965
7	21,00	0,827
6	17,50	0,689
5	14,00	0,551
4	10,50	0,413
3	7,00	0,276
2	3,50	0,138
n	L1 [mm]	L1 [Inch]

STIFTLAENGE L	TOLERANZ
3,2	0,1
	-0,3

- 1) Without locking latches
- 2) Sum of ambient temperature and temperature rise
- 3) Recommendation for manual assembly
- 4) Recommendation for automatic assembly
- 5) Recommendation for wave soldering
- 6) Recommendation for reflow soldering
- 7) Referred to rated cross section and minimum pole number




n.a. = not applicable

Subject to technical changes

SHOWN: SL3.5/4/135F

For the mounting of PCBs, it should be noted that the rated data given in the catalogue relates only to the connection elements. The necessary creepage and clearance paths must be observed in connection with the respective applicant in accordance with VDE 0110. The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller connectors are tested to the DIN VDE 0627 standard, and are valid for its field of application. Provided that the connectors are used to the intended purpose, all requirements with respect to the occurring of electrical, mechanical, thermic and corrosive stress will be satisfied.

<div></div> <div>METRIC TOLERANCES: X. = ±0.3 X.X = ±0.1 X.XX = ±0.05</div>					CAT.NO.: . . .	
	39056/5 07.07.08 HELIS_MA		01	<div>Weidmüller </div> <div>C 42538 01</div> <div>DRAWING NO. SHEET 02 OF 03 SHEET</div>		
	MODIFICATION					
<div></div>		DATE	NAME	<div>SL SMT 3.5/.. /135F</div> <div>STIFTELEISTE</div> <div>PIN HEADER</div>		
	DRAWN	04.07.2008	HELIS_MA			
	RESPONSIBLE		HERTEL_S			
SCALE: 2/1	CHECKED	07.07.2008	HECKERT_M			
SUPERSEDES: . . .	APPROVED		HECKERT_M	PRODUCT FILE: SL-SMT 3.5		
				7312		

Recommended wave soldering profiles

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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.